阅读申明

- 1.本站收集的数据手册和产品资料都来自互联网,版权归原作者所有。如读者和版权方有任何异议请及时告之,我们将妥善解决。
- 2.本站提供的中文数据手册是英文数据手册的中文翻译,其目的是协助用户阅读,该译文无法自动跟随原稿更新,同时也可能存在翻译上的不当。建议读者以英文原稿为参考以便获得更精准的信息。
- 3.本站提供的产品资料,来自厂商的技术支持或者使用者的心得体会等,其内容可能存在描 叙上的差异,建议读者做出适当判断。
- 4.如需与我们联系,请发邮件到marketing@iczoom.com,主题请标有"数据手册"字样。

Read Statement

- 1. The datasheets and other product information on the site are all from network reference or other public materials, and the copyright belongs to the original author and original published source. If readers and copyright owners have any objections, please contact us and we will deal with it in a timely manner.
- 2. The Chinese datasheets provided on the website is a Chinese translation of the English datasheets. Its purpose is for reader's learning exchange only and do not involve commercial purposes. The translation cannot be automatically updated with the original manuscript, and there may also be improper translations. Readers are advised to use the English manuscript as a reference for more accurate information.
- 3. All product information provided on the website refer to solutions from manufacturers' technical support or users the contents may have differences in description, and readers are advised to take the original article as the standard.
- 4. If you have any questions, please contact us at marketing@iczoom.com and mark the subject with "Datasheets".



ASM3P2108A

Peak EMI Reducing Solution

Features

- FCC approved method of EMI attenuation.
- Generates a 1X low EMI spread spectrum clock of the input frequency.
- Input frequency range: 25MHz to 45MHz.
- Internal loop filter minimizes external components and board space.
- Frequency deviation: 1.3%(Typ) @ 32MHz.
- · Low cycle-to-cycle jitter.
- 5.0V ± 5% operating voltage range.
- TTL or CMOS compatible outputs.
- Available in 8-pin SOIC Package.

Product Description

The ASM3P2108A is a versatile spread spectrum frequency modulator designed specifically for input clock frequencies from 25MHz to 45MHz. The ASM3P2108A can generate an EMI reduced clock from crystal, ceramic resonator, or system clock.

The ASM3P2108A reduces electromagnetic interference (EMI) at the clock source, allowing system wide reduction of EMI of down stream clock and data dependent signals. The ASM3P2108A allows significant system cost savings

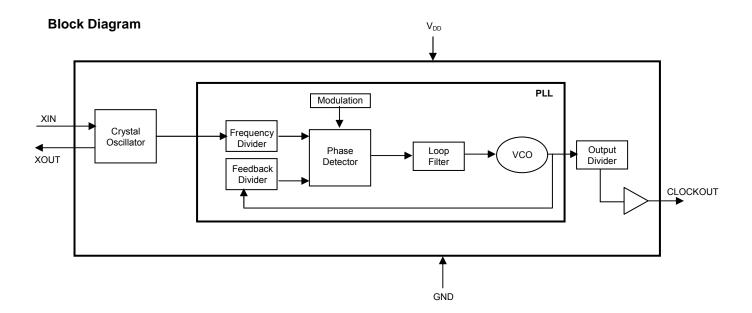
by reducing the number of circuit board layers ferrite beads, shielding and other passive components that are traditionally required to pass EMI regulations.

The ASM3P2108A uses the most efficient and optimized modulation profile approved by the FCC and is implemented in a proprietary all digital method.

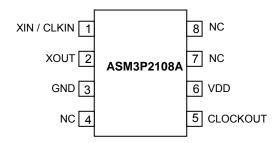
The ASM3P2108A modulates the output of a single PLL in order to "spread" the bandwidth of a synthesized clock, and more importantly, decreases the peak amplitudes of its harmonics. This results in significantly lower system EMI compared to the typical narrow band signal produced by oscillators and most frequency generators. Lowering EMI by increasing a signal's bandwidth is called 'spread spectrum clock generation.'

Applications

The ASM3P2108A is targeted towards EMI management for high speed digital applications such as PC peripheral devices, consumer electronics and embedded controller systems.



Pin Configuration



Pin Description

	5011ptio11				
Pin#	Pin Name	Туре	Description		
1	XIN / CLKIN	I	Crystal connection or external reference frequency input. This pin has dual functions. It can be connected to either an external crystal or an external reference clock.		
2	XOUT	0	Crystal connection. If using an external reference, this pin must be left unconnected.		
3	GND	Р	Ground to entire chip.		
4	NC	-	No connect.		
5	CLOCKOUT	0	Spread spectrum low EMI output.		
6	VDD	Р	Power supply for the entire chip (5V).		
7	NC	-	No connect.		
8	NC	-	No connect.		

Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit
V_{DD} , V_{IN}	Voltage on any pin with respect to Ground	-0.5 to +7.0	V
T _{STG}	Storage temperature	-65 to +125	$\mathcal C$
T _A	Operating temperature	0 to 70	$\mathcal C$
Ts	Max. Soldering Temperature (10 sec)	260	$_{\mathcal{C}}$
TJ	Junction Temperature	150	$^{\circ}$
T_DV	Static Discharge Voltage	2	KV
-•	(As per JEDEC STD22- A114-B)		

Operating Conditions

Symbol	Parameter	Min	Max	Unit
VDD	Supply Voltage with respect to VSS	4.75	5.25	V
T _A	Operating temperature	-40	+85	${\mathbb C}$
CL	Load Capacitance		15	pF
C _{IN}	Input Capacitance		7	pF

DC Electrical Characteristics

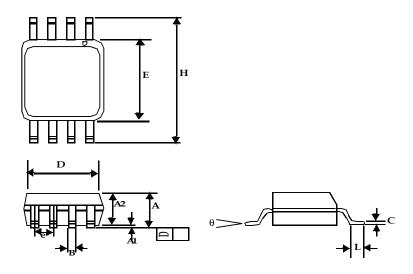
Symbol	Parameter	Min	Тур	Max	Unit
V _{IL}	Input low voltage	GND - 0.3		0.8	V
V _{IH}	Input high voltage	2.0		V _{DD} + 0.3	V
I _{IL}	Input low current		44		μΑ
I _{IH}	Input high current		66		μΑ
I _{XOL}	X _{OUT} output low current (@ 0.4, V _{DD} = 5V)		3		mA
I _{XOH}	X _{OUT} output high current (@2.5V, V _{DD} = 5V)		3		mA
V_{OL}	Output low voltage (V _{DD} = 5V, I _{OL} = 20mA)			0.4	V
V_{OH}	Output high voltage ($V_{DD} = 5V$, $I_{OH} = 20mA$)	2.5			V
I _{CC}	Dynamic supply current normal mode (5V, 32MHz and 15pF loading)		40		mA
I_{DD}	Static supply current standby mode		40		μΑ
V_{DD}	Operating voltage	4.75	5.0	5.25	V
ton	Power up time (first locked clock cycle after power up)		0.18		mS
Z _{out}	Clock out impedance		50		Ω

AC Electrical Characteristics

Symbol	Param	Min	Тур	Max	Unit		
f _{IN}	Input frequency	25		45	MHz		
MODOUT	Output frequency	25		45	MHz		
f _d		Input Frequency = 25MHz		-1.98		- %	
Id		Input Frequency = 45MHz		-0.60			
t _{LH} *	Output rise time (measured at 0		440		pS		
t _{HL} *	Output fall time (measured at 2		300		pS		
t _{JC}	Jitter (cycle to cycle)			±360	pS		
t _D	Output duty cycle	45	50	55	%		
* V _{DD} = +5V, Input Frequency = 32MHz, t _{LH} and t _{HL} are measured into a capacitive load of 15pF							

Package Information

8-Pin SOIC Package



	Dimensions				
Symbol	Inc	hes	Millimeters		
	Min	Max	Min	Max	
A1	0.004	0.010	0.10	0.25	
Α	0.053	0.069	1.35	1.75	
A2	0.049	0.059	1.25	1.50	
В	0.012	0.020	0.31	0.51	
С	0.007	0.010	0.18	0.25	
D	0.193 BSC		4.90 BSC		
Е	0.154 BSC		3.91 BSC		
е	0.050 BSC		1.27 BSC		
Н	0.236 BSC		6.00 BSC		
L	0.016 0.050		0.41	1.27	
θ	0°	8° 0°		8°	

Ordering Codes

Part Number	Marking	Package	Temperature
ASM3P2108AF-08SR	AEG	8-PIN SOIC, TAPE AND REEL, Pb Free	0℃ to +70℃

A "microdot" placed at the end of last row of marking or just below the last row toward the center of package indicates Pb-free.

ON Semiconductor and unare registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. U.S Patent Pending; Timing-Safe and Active Bead are trademarks of PulseCore Semiconductor, a wholly owned subsidiary of ON Semiconductor. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor P.O. Box 5163, Denver, Colorado 80217 USA Phone: 303-675-2175 or 800-344-3860 Toll Free

USA/Canada

Fax: 303-675-2176 or 800-344-3867 Toll Free

USA/Canada

Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free USA/Canada

Europe, Middle East and Africa Technical Support:

Phone: 421 33 790 2910 Japan Customer Focus Center

Phone: 81-3-5773-3850

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your

local Sales Representative